

## Dual N-Channel 25-V (D-S) MOSFET

### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ )  | $I_D$ (A) <sup>a, e</sup> | $Q_g$ (Typ.) |
|--------------|----------------------------|---------------------------|--------------|
| 25           | 0.0195 at $V_{GS} = 4.5$ V | 8                         | 11           |
|              | 0.026 at $V_{GS} = 2.5$ V  | 8                         |              |

### FEATURES

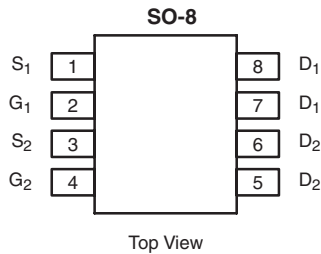
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 %  $R_g$  and UIS Tested



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

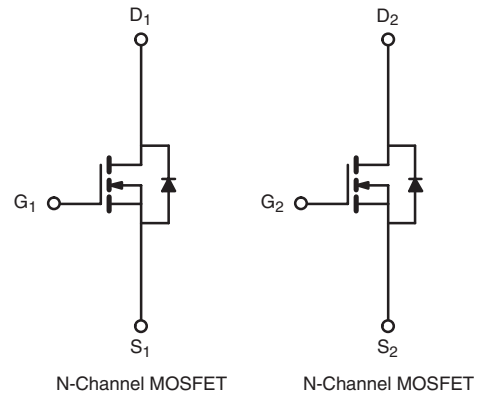
### APPLICATIONS

- Synchronous Buck Converter



Top View

**Ordering Information:** Si4226DY-T1-E3 (Lead (Pb)-free)  
Si4226DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$ , unless otherwise noted

| Parameter                                              | Symbol         | Limit                    | Unit             |
|--------------------------------------------------------|----------------|--------------------------|------------------|
| Drain-Source Voltage                                   | $V_{DS}$       | 25                       | V                |
| Gate-Source Voltage                                    | $V_{GS}$       | $\pm 12$                 |                  |
| Continuous Drain Current ( $T_J = 150^\circ\text{C}$ ) | $I_D$          | $T_C = 25^\circ\text{C}$ | A                |
|                                                        |                | $T_C = 70^\circ\text{C}$ |                  |
|                                                        |                | $T_A = 25^\circ\text{C}$ |                  |
|                                                        |                | $T_A = 70^\circ\text{C}$ |                  |
| Pulsed Drain Current (10 $\mu\text{s}$ Pulse Width)    | $I_{DM}$       | 30                       | A                |
| Source-Drain Current Diode Current                     | $I_S$          | $T_C = 25^\circ\text{C}$ |                  |
|                                                        |                | $T_A = 25^\circ\text{C}$ |                  |
| Pulsed Source-Drain Current                            | $I_{SM}$       | 30                       |                  |
| Single Pulse Avalanche Current                         | $I_{AS}$       | 10                       | mJ               |
| Single Pulse Avalanche Energy                          | $E_{AS}$       | 5                        |                  |
| Maximum Power Dissipation                              | $P_D$          | $T_C = 25^\circ\text{C}$ |                  |
|                                                        |                | $T_C = 70^\circ\text{C}$ |                  |
|                                                        |                | $T_A = 25^\circ\text{C}$ |                  |
|                                                        |                | $T_A = 70^\circ\text{C}$ |                  |
| Operating Junction and Storage Temperature Range       | $T_J, T_{stg}$ | - 55 to 150              | $^\circ\text{C}$ |

### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol     | Typical | Maximum | Unit                      |
|---------------------------------------------|------------|---------|---------|---------------------------|
| Maximum Junction-to-Ambient <sup>b, d</sup> | $R_{thJA}$ | 50      | 62.5    | $^\circ\text{C}/\text{W}$ |
| Maximum Junction-to-Foot (Drain)            | $R_{thJF}$ | 30      | 38      |                           |

Notes:

- Based on  $T_C = 25^\circ\text{C}$ .
- Surface Mounted on 1" x 1" FR4 board.
- $t = 10$  s.
- Maximum under Steady State conditions is 110  $^\circ\text{C}/\text{W}$ .
- Package limited.

| SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted |                                      |                                                                                                                                   |      |        |        |       |
|---------------------------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|------|--------|--------|-------|
| Parameter                                                     | Symbol                               | Test Conditions                                                                                                                   | Min. | Typ.   | Max.   | Unit  |
| Static                                                        |                                      |                                                                                                                                   |      |        |        |       |
| Drain-Source Breakdown Voltage                                | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                                    | 25   |        |        | V     |
| V <sub>DS</sub> Temperature Coefficient                       | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = 250 μA                                                                                                           |      | 26     |        | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient                   | ΔV <sub>GS(th)</sub> /T <sub>J</sub> |                                                                                                                                   |      | - 4    |        |       |
| Gate Threshold Voltage                                        | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                                                       | 0.6  |        | 2.0    | V     |
| Gate Body Leakage                                             | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 12 V                                                                                   |      |        | 100    | nA    |
| Zero Gate Voltage Drain Current                               | I <sub>DSS</sub>                     | V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V                                                                                     |      |        | 1      | μA    |
|                                                               |                                      | V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                                                             |      |        | 10     |       |
| On-State Drain Current <sup>b</sup>                           | I <sub>D(on)</sub>                   | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V                                                                                     | 20   |        |        | A     |
| Drain-Source On-State Resistance <sup>b</sup>                 | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7 A                                                                                     |      | 0.0155 | 0.0195 | Ω     |
|                                                               |                                      | V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 5 A                                                                                     |      | 0.020  | 0.026  |       |
| Forward Transconductance <sup>b</sup>                         | g <sub>fs</sub>                      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7 A                                                                                      |      | 40     |        | S     |
| Dynamic <sup>a</sup>                                          |                                      |                                                                                                                                   |      |        |        |       |
| Input Capacitance                                             | C <sub>iss</sub>                     | N-Channel<br>V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                                             |      | 1255   |        | pF    |
| Output Capacitance                                            | C <sub>oss</sub>                     |                                                                                                                                   |      | 185    |        |       |
| Reverse Transfer Capacitance                                  | C <sub>rss</sub>                     |                                                                                                                                   |      | 90     |        |       |
| Total Gate Charge                                             | Q <sub>g</sub>                       | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A                                                              |      | 24     | 36     | nC    |
|                                                               |                                      | N-Channel<br>V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 8 A                                                |      | 11     | 17     |       |
| Gate-Source Charge                                            | Q <sub>gs</sub>                      |                                                                                                                                   |      | 2      |        |       |
| Gate-Drain Charge                                             | Q <sub>gd</sub>                      |                                                                                                                                   |      | 2.5    |        |       |
| Gate Resistance                                               | R <sub>g</sub>                       | f = 1 MHz                                                                                                                         | 0.3  | 1.4    | 2.8    | Ω     |
| Turn-On Delay Time                                            | t <sub>d(on)</sub>                   | N-Channel<br>V <sub>DD</sub> = 15 V, R <sub>L</sub> = 3 Ω<br>I <sub>D</sub> ≅ 5 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 Ω |      | 8      | 16     | ns    |
| Rise Time                                                     | t <sub>r</sub>                       |                                                                                                                                   |      | 9      | 18     |       |
| Turn-Off Delay Time                                           | t <sub>d(off)</sub>                  |                                                                                                                                   |      | 24     | 40     |       |
| Fall Time                                                     | t <sub>f</sub>                       |                                                                                                                                   |      | 8      | 16     |       |
| Turn-On Delay Time                                            | t <sub>d(on)</sub>                   | N-Channel<br>V <sub>DD</sub> = 15 V, R <sub>L</sub> = 3 Ω<br>I <sub>D</sub> ≅ 5 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω  |      | 14     | 25     |       |
| Rise Time                                                     | t <sub>r</sub>                       |                                                                                                                                   |      | 10     | 20     |       |
| Turn-Off Delay Time                                           | t <sub>d(off)</sub>                  |                                                                                                                                   |      | 30     | 50     |       |
| Fall Time                                                     | t <sub>f</sub>                       |                                                                                                                                   |      | 8      | 16     |       |
| Drain-Source Body Diode Characteristics                       |                                      |                                                                                                                                   |      |        |        |       |
| Continuous Source-Drain Diode Current                         | I <sub>S</sub>                       | T <sub>C</sub> = 25 °C                                                                                                            |      |        | 2.6    | A     |
| Pulse Diode Forward Current <sup>a</sup>                      | I <sub>SM</sub>                      |                                                                                                                                   |      |        | 30     |       |
| Body Diode Voltage                                            | V <sub>SD</sub>                      | I <sub>S</sub> = 2 A                                                                                                              |      | 0.73   | 1.2    | V     |
| Body Diode Reverse Recovery Time                              | t <sub>rr</sub>                      | N-Channel<br>I <sub>F</sub> = 10 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C                                                      |      | 25     | 50     | ns    |
| Body Diode Reverse Recovery Charge                            | Q <sub>rr</sub>                      |                                                                                                                                   |      | 14     | 28     | nC    |
| Reverse Recovery Fall Time                                    | t <sub>a</sub>                       |                                                                                                                                   |      | 12     |        | ns    |
| Reverse Recovery Rise Time                                    | t <sub>b</sub>                       |                                                                                                                                   |      | 13     |        |       |

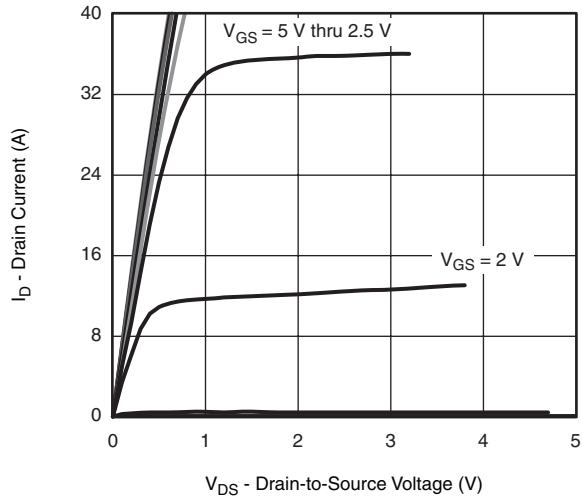
Notes:

a. Guaranteed by design, not subject to production testing.

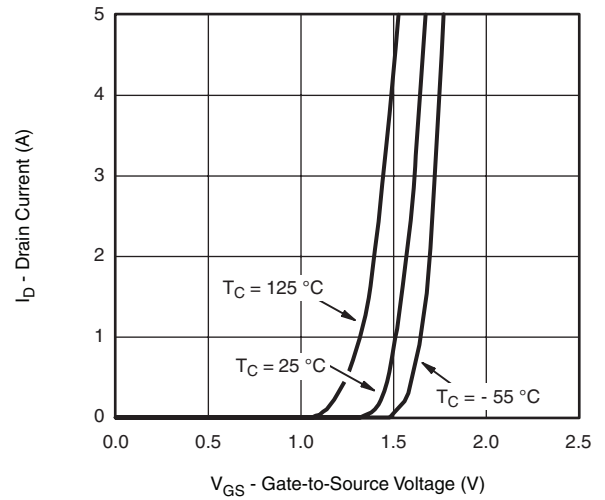
b. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

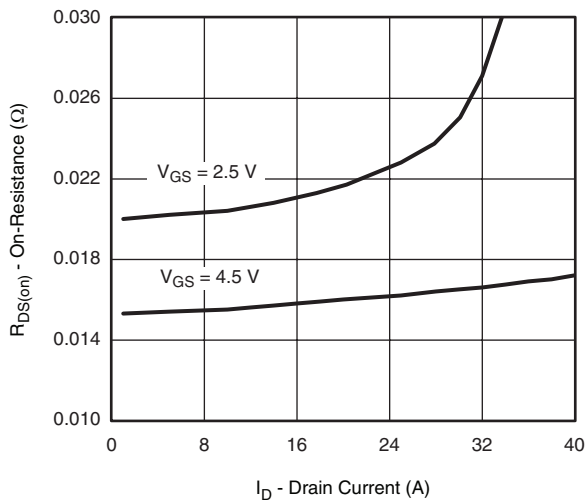
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



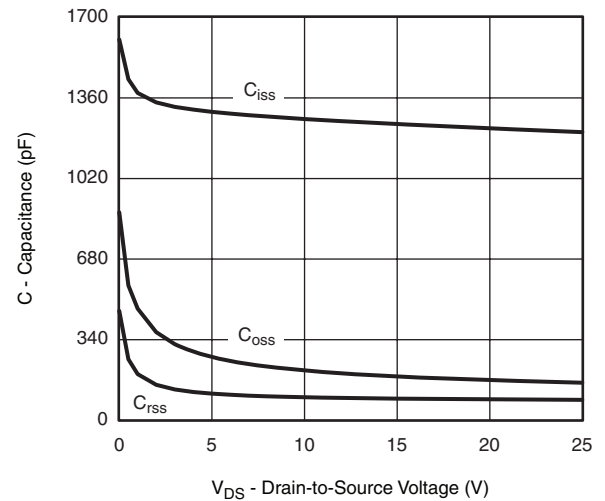
Output Characteristics



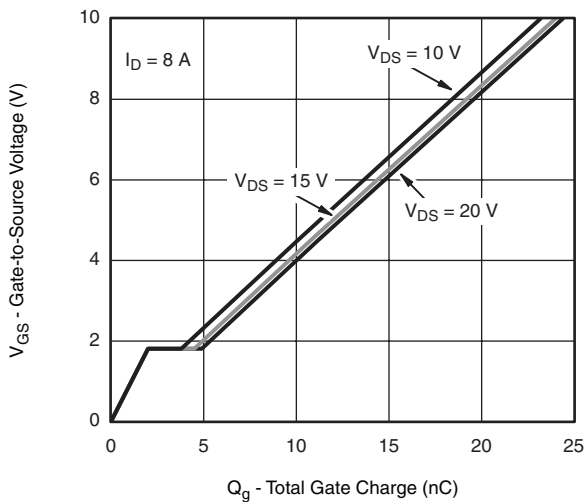
Transfer Characteristics



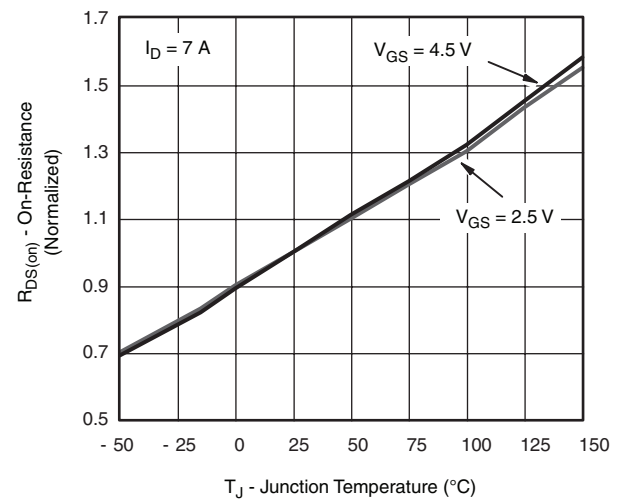
On-Resistance vs. Drain Current



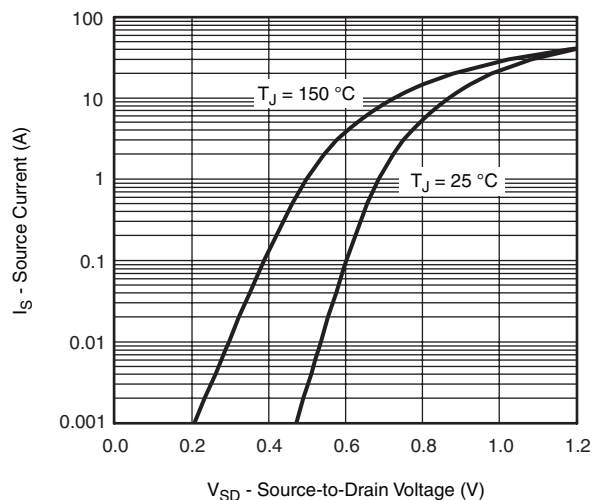
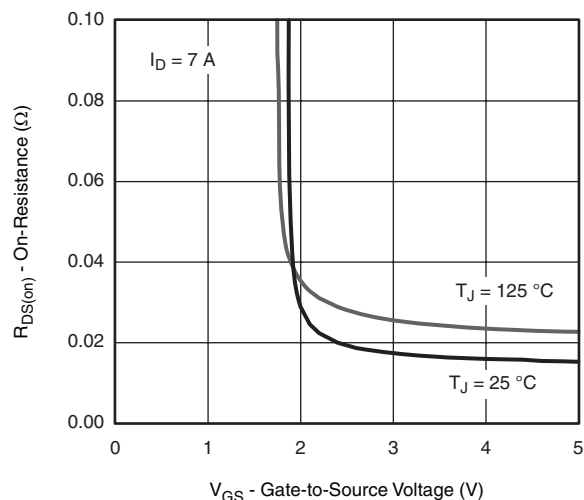
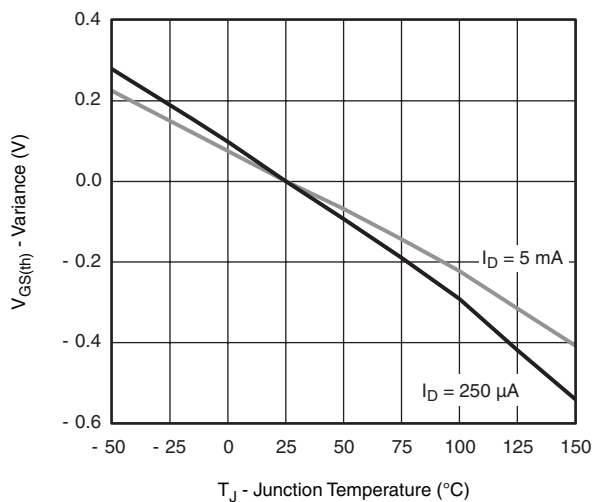
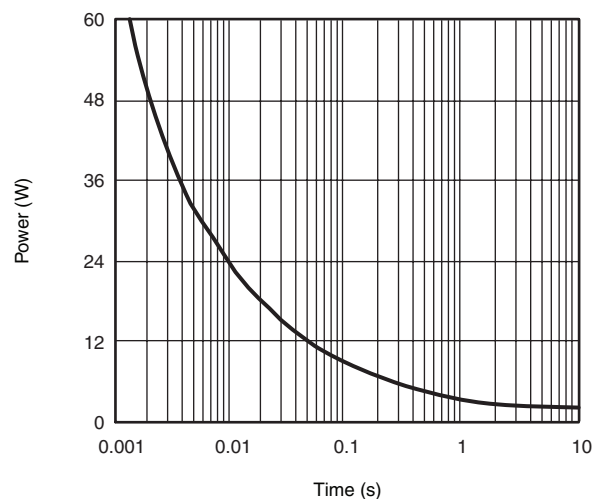
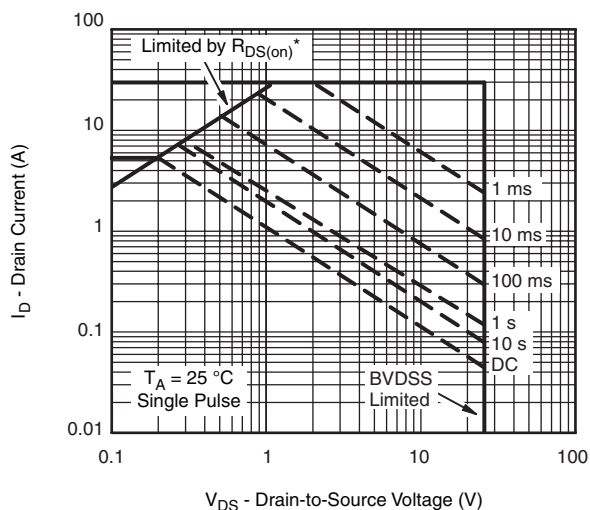
Capacitance



Gate Charge



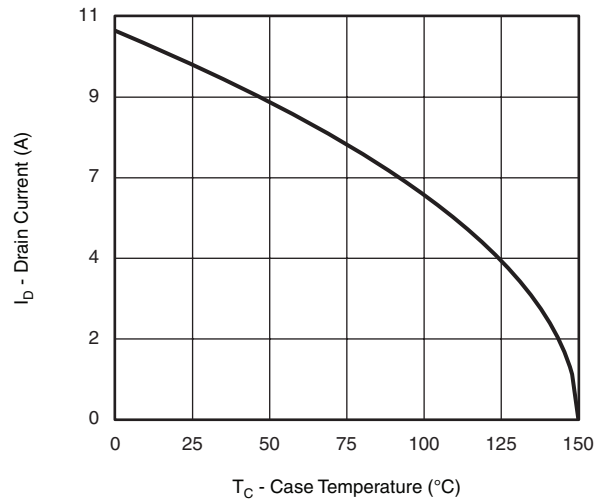
On-Resistance vs. Junction Temperature

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power, Junction-to-Ambient**

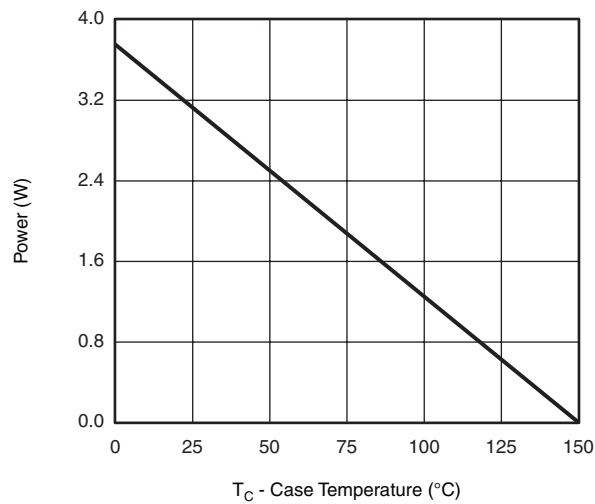
$V_{DS}$  - Drain-to-Source Voltage (V)  
 \*  $V_{DS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

**Safe Operating Area**

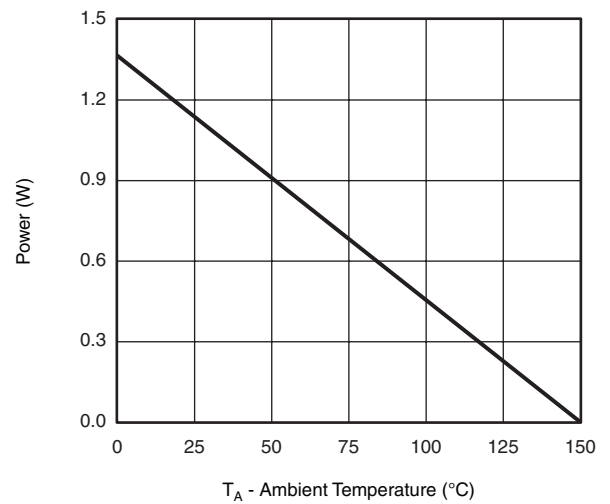
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



**Current Derating\***

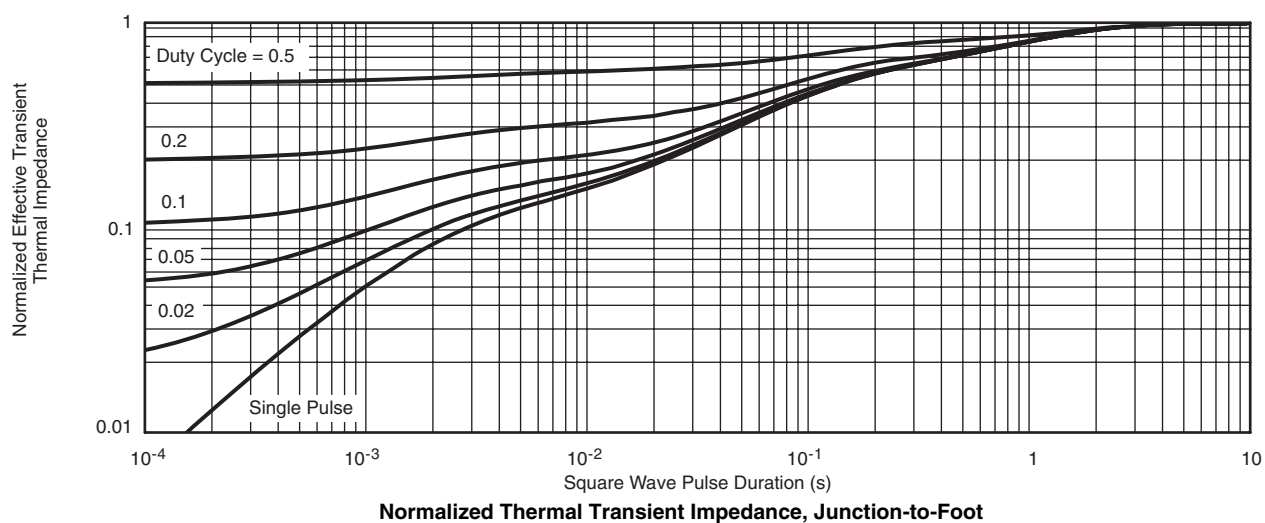
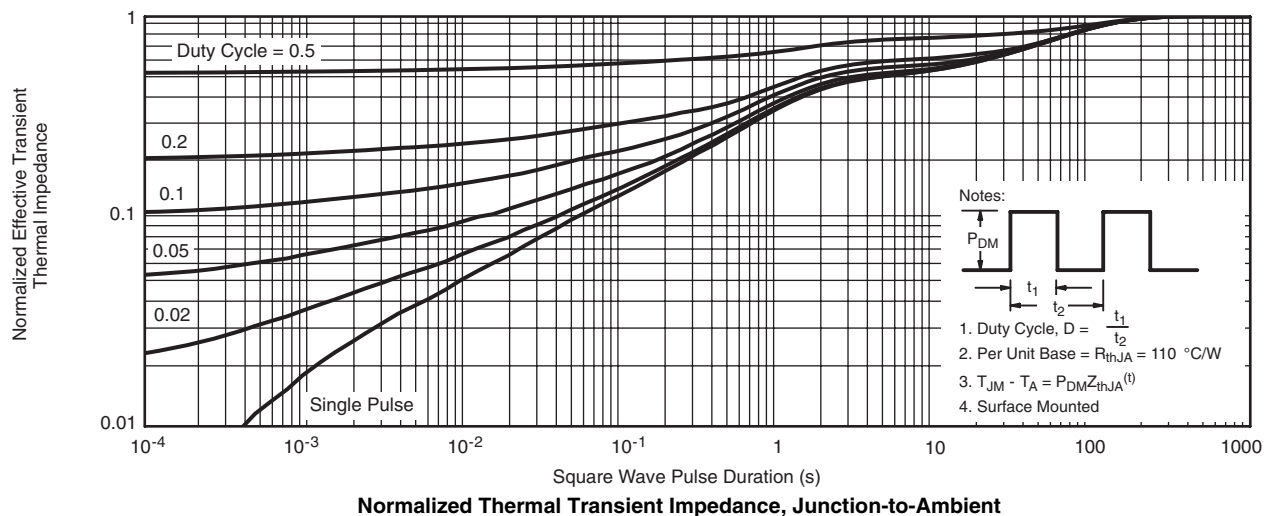


**Power, Junction-to-Foot**



**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

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## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



| DIM                            | MILLIMETERS |      | INCHES    |       |
|--------------------------------|-------------|------|-----------|-------|
|                                | Min         | Max  | Min       | Max   |
| A                              | 1.35        | 1.75 | 0.053     | 0.069 |
| A <sub>1</sub>                 | 0.10        | 0.20 | 0.004     | 0.008 |
| B                              | 0.35        | 0.51 | 0.014     | 0.020 |
| C                              | 0.19        | 0.25 | 0.0075    | 0.010 |
| D                              | 4.80        | 5.00 | 0.189     | 0.196 |
| E                              | 3.80        | 4.00 | 0.150     | 0.157 |
| e                              | 1.27 BSC    |      | 0.050 BSC |       |
| H                              | 5.80        | 6.20 | 0.228     | 0.244 |
| h                              | 0.25        | 0.50 | 0.010     | 0.020 |
| L                              | 0.50        | 0.93 | 0.020     | 0.037 |
| q                              | 0°          | 8°   | 0°        | 8°    |
| S                              | 0.44        | 0.64 | 0.018     | 0.026 |
| ECN: C-06527-Rev. I, 11-Sep-06 |             |      |           |       |
| DWG: 5498                      |             |      |           |       |

## RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads  
Dimensions in Inches/(mm)

[Return to Index](#)



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